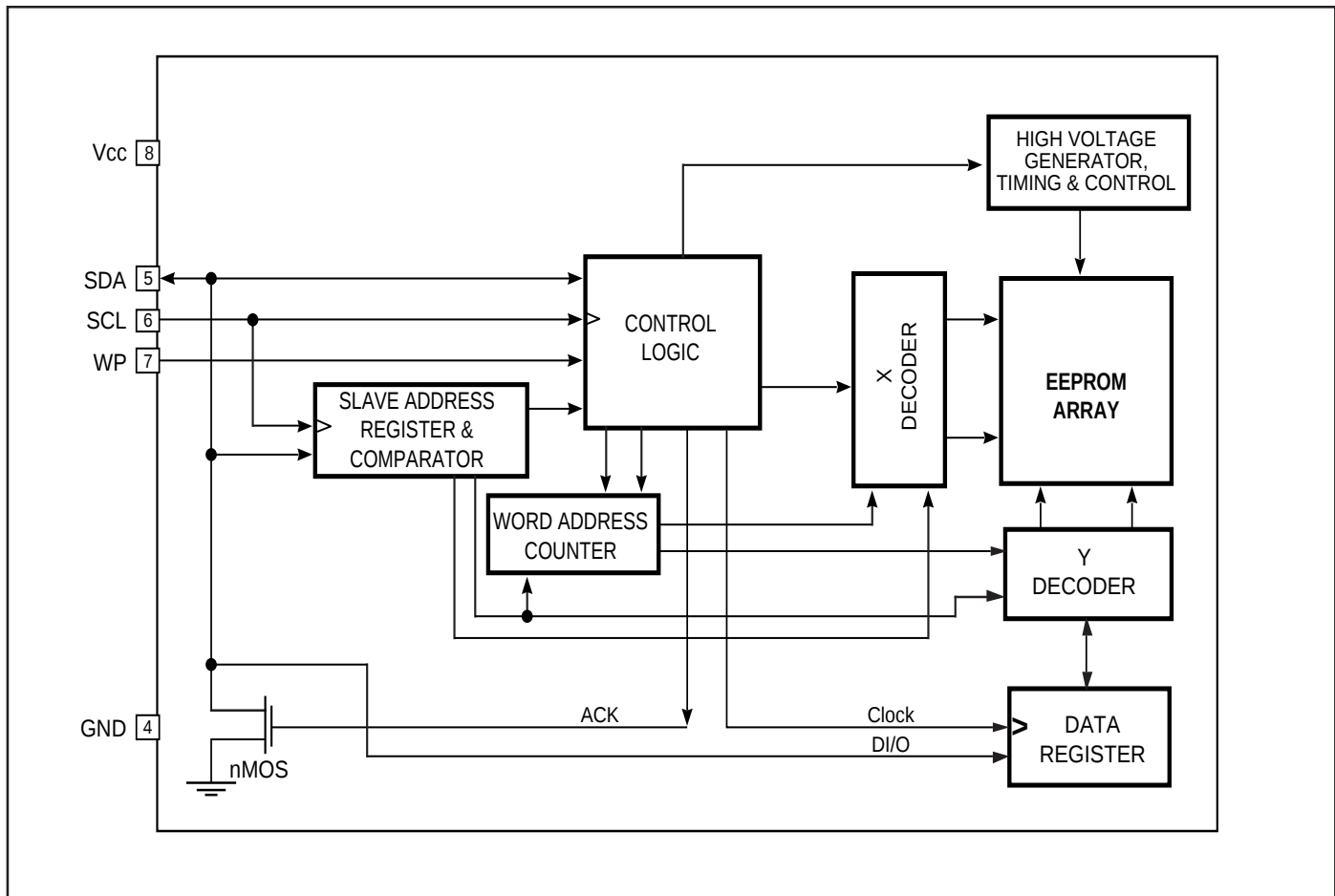


FUNCTIONAL BLOCK DIAGRAM

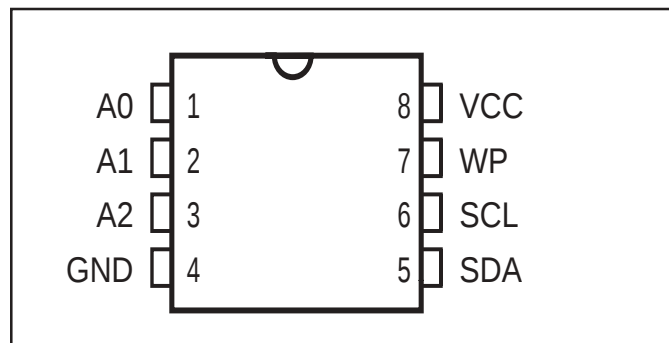


PIN CONFIGURATION

8-Pin DIP and SOIC

8 Pin TSSOP (1K, 2K, 4K and 8K)

8-Pin MSOP (1K, 2K)



PIN DESCRIPTIONS

A0-A2	Address Inputs
SDA	Serial Address/Data I/O
SCL	Serial Clock Input
WP	Write Protect Input
Vcc	Power Supply
GND	Ground

SCL

This input clock pin is used to synchronize the data transfer to and from the device.

SDA

The SDA is a Bi-directional pin used to transfer addresses and data into and out of the device. The SDA pin is an open drain output and can be wire-Or'ed with other open drain or open collector outputs. The SDA bus *requires* a pullup resistor to Vcc.

A0, A1, A2

The A0, A1 and A2 are the device address inputs. The IS24C01 and IS24C02 use the A0, A1, and A2 for hardware addressing and a total of 8 devices may be used on a single bus system.

The IS24C04 uses A1 and A2 pins for hardwire addressing and a total of four devices may be addressed on a single bus system. The A0 pin is not used by IS24C04. This pin can be left floating or tied to GND or Vcc.

The IS24C08 only use A2 input for hardwire addressing and a total of two devices may be addressed on a single bus system. The A0 and A1 pins are not used by IS24C08. They may be left floating or tied to either GND or Vcc.

These pins are not used by IS24C16. A0 and A1 may be left floating or tied to either GND or Vcc. A2 should be tied to either GND or Vcc.

WP

WP is the Write Protect pin. On the 24C01, 24C02, IS24C04 and 24C08, if the WP pin is tied to Vcc the entire array becomes Write Protected (Read only). On the 24C16, if the WP pin is tied to Vcc the upper half array becomes Write Protected (Read only). When WP is tied to GND or left floating normal read/write operations are allowed to the device.

DEVICE OPERATION

The IS24CXX family features a serial communication and supports a bi-directional 2-wire bus transmission protocol.

2-WIRE BUS

The two-wire bus is defined as a Serial Data line (SDA), and a Serial Clock Line (SCL). The protocol defines any device that sends data onto the SDA bus as a transmitter, and the receiving devices as a receiver. The bus is controlled by MASTER device which generates the SCL, controls the bus access and generates the STOP and START conditions. The IS24CXX is the SLAVE device on the bus.

THE BUS PROTOCOL:

- Data transfer may be initiated only when the bus is not busy
- During a data transfer, the data line must remain stable whenever the clock line is high. Any changes in the data line while the clock line is high will be interpreted as a START or STOP condition.

The state of the data line represents valid data when after a START condition, the data line is stable for the duration of the HIGH period of the clock signal. The data on the line must be changed during the LOW period of the clock signal. There is one clock pulse per bit of data. Each data transfer is initiated with a START condition and terminated with a STOP condition.

START CONDITION

The START condition precedes all commands to the devices and is defined as a HIGH to LOW transition of SDA when SCL is HIGH. The IS24CXX monitors the SDA and SCL lines and will not respond until the START condition is met.

STOP CONDITION

The STOP condition is defined as a LOW to HIGH transition of SDA when SCL is HIGH. All operations must end with a STOP condition.

ACKNOWLEDGE

After a successful data transfer, each receiving device is required to generate an acknowledge. The Acknowledging device pulls down the SDA line.

DEVICE ADDRESSING

The MASTER begins a transmission by sending a START condition. The MASTER then sends the address of the particular slave devices it is requesting. The SLAVE address is 8 bytes.

The four most significant bytes of the address are fixed as 1010 for the IS24CXX.

For the IS24C16, the bytes (B2, B1 and B0) are used for memory page addressing (the IS24C16 is organized as eight blocks of 256 bytes).

For the IS24C04 out of the next three bytes, B0 is for Memory Page Addressing (the IS24C04 is organized as two blocks of 256 bytes) and A2 and A1 bytes are used as device address bytes and must compare to its hard-wire inputs pins (A2 and A1). Up to four IS24C04's may be individually addressed by the system. The page addressing bytes for IS24Cxx should be considered the most significant bytes of the data word address which follows.

For the IS24C08 out of the next three bytes, B1 and B0 are for memory page addressing (the IS24C08 is organized as four blocks of 256 bytes) and the A2 bit is used as device address bit and must compare to its hard-wired input pin (A2). Up to two IS24C08 may be individually addressed by the system. The page addressing bytes for IS24CXX should be considered the most significant bytes of the data word address which follows.

For the IS24C01 and IS24C02, the A0, A1, and A2 are used as device address bytes and must compare to its hard-wired input pins (A0, A1, and A2) Up to Eight IS24C01 and/or IS24C02's may be individually addressed by the system.

The last bit of the slave address specifies whether a Read or Write operation is to be performed. When this bit is set to 1, a Read operation is selected, and when set to 0, a Write operation is selected.

After the MASTER sends a START condition and the SLAVE address byte, the IS24CXX monitors the bus and responds with an Acknowledge (on the SDA line) when its address matches the transmitted slave address. The IS24CXX pulls down the SDA line during the ninth clock cycle, signaling that it received the eight bytes of data. The IS24CXX then performs a Read or Write operation depending on the state of the $\overline{R/\overline{W}}$ bit.

WRITE OPERATION

BYTE WRITE

In the Byte Write mode, the Master device sends the START condition and the slave address information (with the $\overline{R/\overline{W}}$ set to Zero) to the Slave device. After the Slave generates an acknowledge, the Master sends the byte address that is to be written into the address pointer of the IS24CXX. After receiving another acknowledge from the Slave, the Master device transmits the data byte to be written into the address memory location. The IS24CXX acknowledges once more and the Master generates the STOP condition, at which time the device begins its internal programming cycle. While this internal cycle is in progress, the device will not respond to any request from the Master device.

PAGE WRITE

The IS24CXX is capable of page-WRITE (8-byte for 24C01/02 and 16-byte for 24C04/08/16) operation. A page-WRITE is initiated in the same manner as a byte write, but instead of terminating the internal write cycle after the first data word is transferred, the master device can transmit up to N more bytes (N=7 for 24C01/02 and N=15 for 24C04/08/16). After the receipt of each data word, the IS24CXX responds immediately with an ACKnowledge on SDA line, and the three lower (24C01/24C02) or four lower (24C04/24C08/24C16) order data word address bits are internally incremented by one, while the higher order bits of the data word address remain constant. If the master device should transmit more than N+1 (N=7 for 24C01/02 and N=15 for 24C04/08/16) words, prior to issuing the STOP condition, the address counter will “roll over,” and the previously written data will be overwritten. Once all N+1 (N=7 for 24C01/02 and N=15 for 24C04/08/16) bytes are received and the STOP condition has been sent by the Master, the internal programming cycle begins. At this point, all received data is written to the IS24CXX in a single write cycle. All inputs are disabled until completion of the internal WRITE cycle.

ACKNOWLEDGE POLLING

The disabling of the inputs can be used to take advantage of the typical write cycle time. Once the stop condition is issued to indicate the end of the host's write operation, the IS24CXX initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the slave address for a write operation. If the IS24CXX is still busy with the write operation, no ACK will be returned. If the IS24CXX has completed the write operation, an ACK will be returned and the host can then proceed with the next read or write operation.

READ OPERATION

READ operations are initiated in the same manner as WRITE operations, except that the read/write bit of the slave address is set to “1”. There are three READ operation options: current address read, random address read and sequential read.

CURRENT ADDRESS READ

The IS24CXX contains an internal address counter which maintains the address of the last byte accessed, incremented by one. For example, if the previous operation is either a read or write operation addressed to the address location n, the internal address counter would increment to address location n+1. When the IS24CXX receives the Device Addressing Byte with a READ operation (read/write bit set to “1”), it will respond an ACKnowledge and transmit the 8-bit data word stored at address location n+1. The master will not acknowledge the transfer but does generate a STOP

condition and the IS24CXX discontinues transmission. If 'n' is the last byte of the memory, then the data from location '0' will be transmitted. (Refer to Current Address Read Diagram.)

RANDOM ADDRESS READ

Selective READ operations allow the Master device to select at random any memory location for a READ operation. The Master device first performs a 'dummy' write operation by sending the START condition, slave address and word address of the location it wishes to read. After the IS24CXX acknowledge the word address, the Master device resends the START condition and the slave address, this time with the R/W bit set to one. The IS24CXX then responds with its acknowledge and sends the data requested. The master device does not send an acknowledge but will generate a STOP condition. (Refer to Random Address Read Diagram.)

SEQUENTIAL READ

Sequential Reads can be initiated as either a Current Address Read or Random Address Read. After the IS24CXX sends initial byte sequence, the master device now responds with an ACKnowledge indicating it requires additional data from the IS24CXX. The IS24CXX continues to output data for each ACKnowledge received. The master device terminates the sequential READ operation by pulling SDA HIGH (no ACKnowledge) indicating the last data word to be read, followed by a STOP condition.

The data output is sequential, with the data from address n followed by the data from address n+1, ... etc. The address counter increments by one automatically, allowing the entire memory contents to be serially read during sequential read operation. When the memory address boundary (127 for IS24C01; 255 for IS24C02; 511 for IS24C04; 1023 for IS24C08; 2047 for IS24C16) is reached, the address counter “rolls over” to address 0, and the IS24CXX continues to output data for each ACKnowledge received. (Refer to Sequential Read Operation Starting with a Random Address READ Diagram.)

The diagram illustrates the I2C connection between a Master Transmitter/Receiver and an IS24Cxx EEPROM. The Master Transmitter/Receiver is connected to the SCL (Serial Clock Line) and SDA (Serial Data Line) of the IS24Cxx. The SCL line is connected to the SCL pin of the Master Transmitter/Receiver and the SCL pin of the IS24Cxx. The SDA line is connected to the SDA pin of the Master Transmitter/Receiver and the SDA pin of the IS24Cxx. A pull-up resistor is connected between the SCL line and Vcc.

The diagram shows three signals over time:

- SCL from Master:** A clock signal with high and low periods. The data bytes 1 through 9 are transmitted during the high periods of the clock.
- Data Output from Transmitter:** The data being sent by the master. It shows the sequence of bytes 1 through 9 being transmitted.
- Data Output from Receiver:** The data being received by the slave. It shows the sequence of bytes 1 through 9 being received, followed by an acknowledgment (ACK) signal.

Key timing parameters are indicated:

- tAA:** The time interval between the falling edge of the SCL signal and the falling edge of the ACK signal.
- tAA:** The time interval between the falling edge of the SCL signal and the rising edge of the ACK signal.

The diagram illustrates the timing for a single-byte read operation. It shows two signals: SCL (Serial Clock) and SDA (Serial Data). The sequence begins with a START condition, indicated by a shaded box labeled "START Condition". Following the START, the SCL signal transitions to a high state, and the SDA signal transitions to a high state, indicating a read operation. The signals remain high for a period, then transition to a low state. This sequence is repeated, as indicated by the break symbol (two parallel slanted lines). The operation concludes with a STOP condition, indicated by a shaded box labeled "STOP Condition".

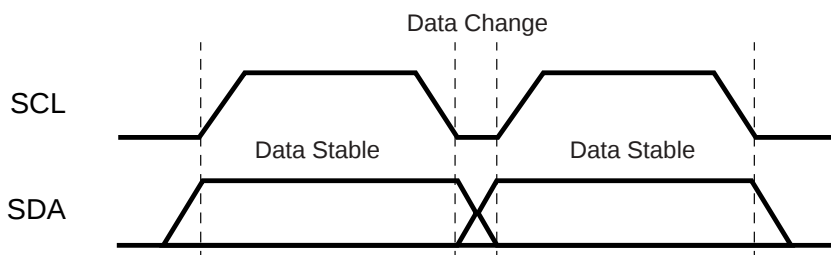
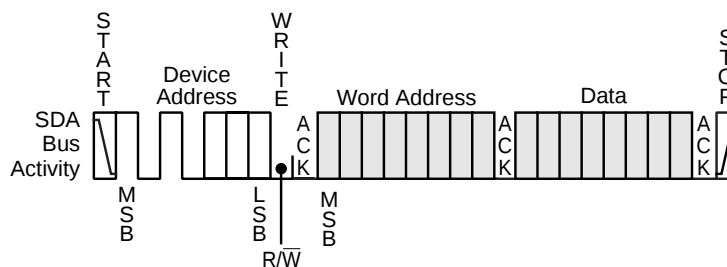


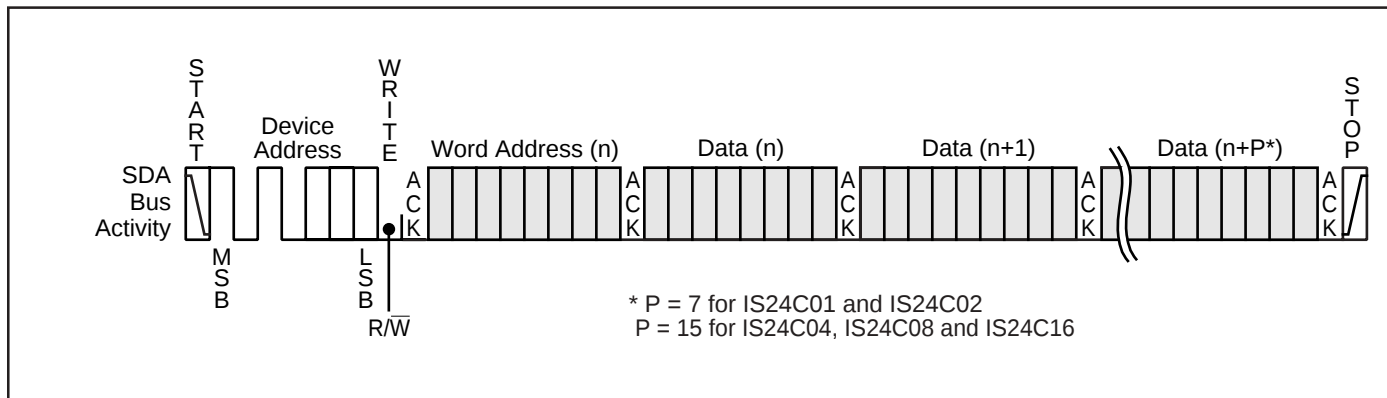
Diagram illustrating the bit patterns for IS24C01, IS24C02, IS24C04, and IS24C08. The bits are labeled BIT, and the address bits are labeled A2, A1, A0, B0, B1, B2. The read/write control bit is labeled R/W.

BIT	7	6	5	4	3	2	1	0	
	1	0	1	0	A2	A1	A0	R/W	IS24C01
	1	0	1	0	A2	A1	A0	R/W	IS24C02
	1	0	1	0	A2	A1	B0	R/W	IS24C04
	1	0	1	0	A2	B1	B0	R/W	IS24C08

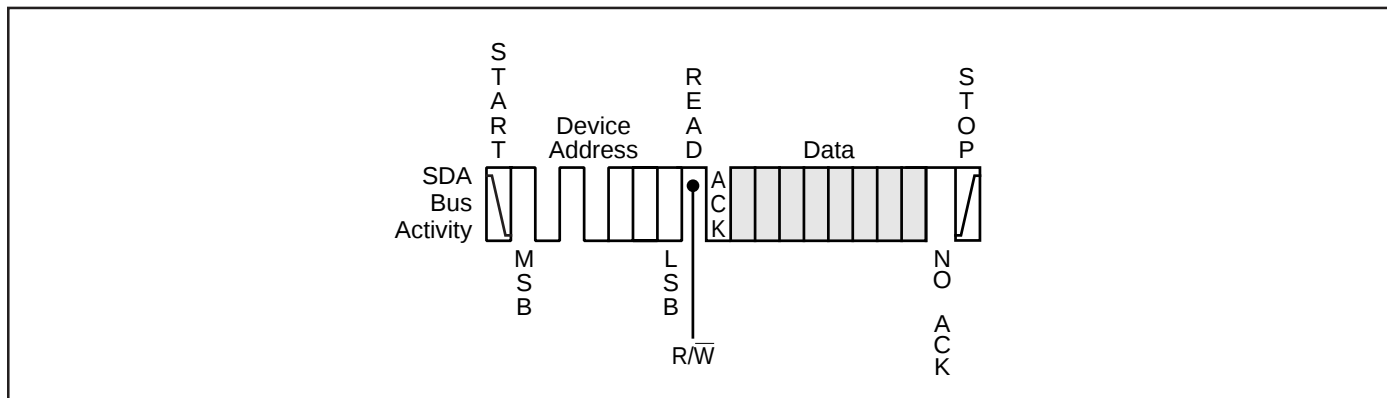
MSB (Most Significant Bit) is indicated for the address bits (A2, A1, A0, B0, B1, B2).
LSB (Least Significant Bit) is indicated for the read/write control bit (R/W).



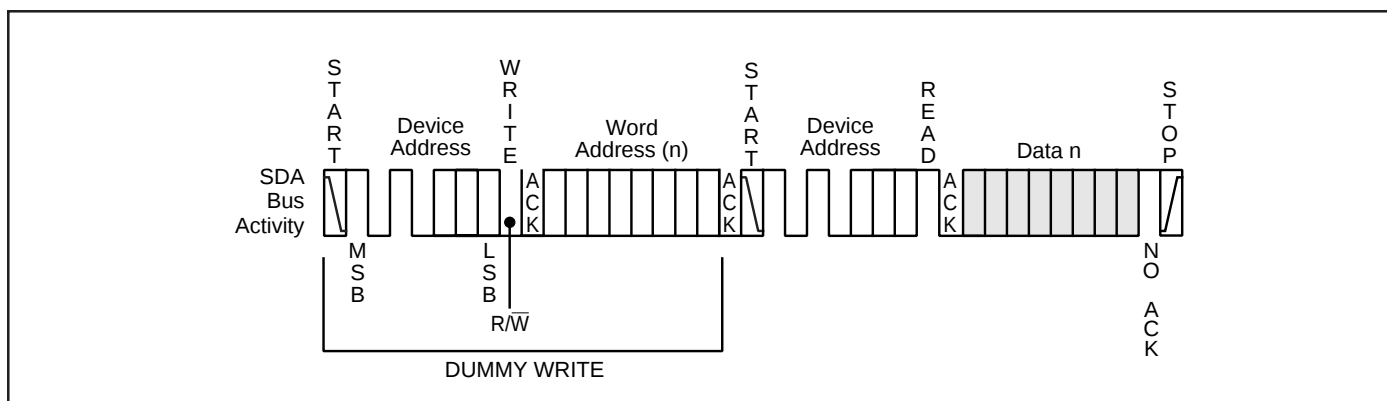
PAGE WRITE



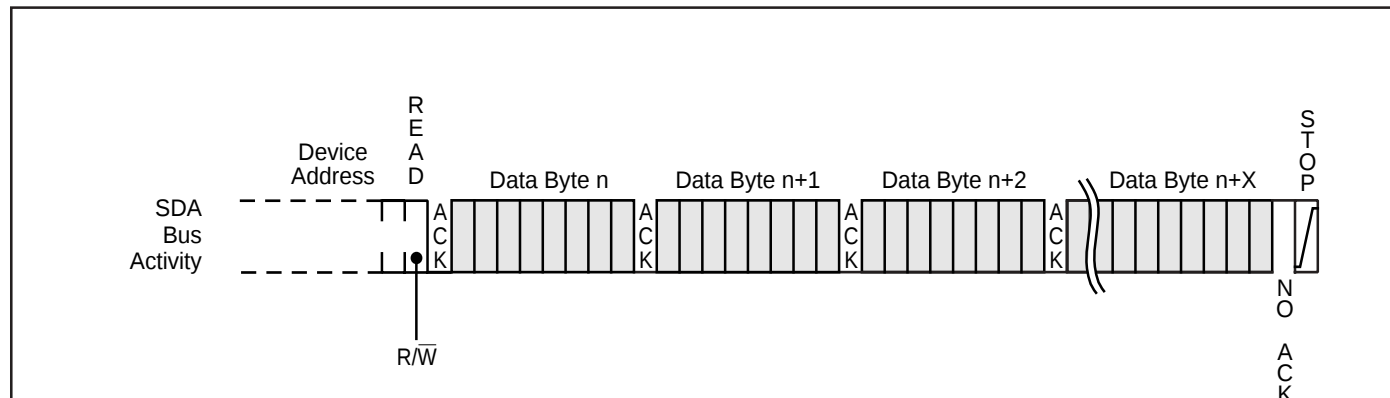
CURRENT ADDRESS READ



RANDOM ADDRESS READ



SEQUENTIAL READ



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Value	Unit
V _S	Supply Voltage	0.5 to +6.25	V
V _P	Voltage on Any Pin	−0.5 to V _{CC} + 0.5	V
T _{BIAS}	Temperature Under Bias	−40 to +85	°C
T _{STG}	Storage Temperature	−65 to +150	°C
I _{OUT}	Output Current	5	mA

Notes:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE**(IS24C01-2, IS24C02-2, IS24C04-2, IS24C08-2, & IS24C16-2)**

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	1.8V to 5.5V
Industrial	−40°C to +85°C	1.8V to 5.5V

OPERATING RANGE**(IS24C01-3, IS24C02-3, IS24C04-3, IS24C08-3, & IS24C16-3)**

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	2.5V to 5.5V
Industrial	−40°C to +85°C	2.5V to 5.5V
Automotive	−40°C to +125°C	2.7V to 5.5V

Note: Automotive data is preliminary.

OPERATING RANGE**(IS24C01-5, IS24C02-5, IS24C04-5, IS24C08-5, & IS24C16-5)**

Range	Ambient Temperature	V _{CC}
Automotive	−40°C to +125°C	4.5V to 5.5V

Note: Automotive data is preliminary.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _{OL1}	Output LOW Voltage	V _{CC} = 1.8V, I _{OL} = 0.15 mA	—	0.2	V
V _{OL2}	Output LOW Voltage	V _{CC} = 2.5V, I _{OL} = 1.0 mA	—	0.4	V
V _{IH}	Input HIGH Voltage		V _{CC} × 0.7	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage		−1.0	V _{CC} × 0.3	V
I _{LI}	Input Leakage Current	V _{IN} = V _{CC} max.	—	3	μA
I _{LO}	Output Leakage Current		—	3	μA

Notes: V_{IL} min and V_{IH} max are reference only and are not tested.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
I _{CC1}	V _{CC} Operating Current	READ at 100 KHz (V _{CC} = 5V)	—	1.0	mA
I _{CC2}	V _{CC} Operating Current	WRITE at 100 KHz (V _{CC} = 5V)	—	3.0	mA
I _{SB1}	Standby Current	V _{CC} = 1.8V	—	4.0	μA
I _{SB2}	Standby Current	V _{CC} = 5.5V	—	8.0	μA

CAPACITANCE^(1,2)

Symbol	Parameter	Conditions	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	8	pF

Notes:

1. Tested initially and after any design or process changes that may affect these parameters.
2. Test conditions: T_A = 25°C, f = 1 MHz, V_{CC} = 5.0V.

AC ELECTRICAL CHARACTERISTICS (Over Operating Range)**Commercial** ($T_A = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$) **Industrial** ($T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$)

Symbol	Parameter	Test Conditions	1.8V-5.5V		2.5V-5.5V		Unit
			Min.	Max.	Min.	Max.	
f _{SCL}	SCL Clock Frequency		0	100	0	400	KHz
T	Noise Suppression Time ⁽¹⁾		—	100	—	50	ns
t _{LOW}	Clock LOW Period		4.7	—	1.2	—	μs
t _{HIGH}	Clock HIGH Period		4	—	0.6	—	μs
t _{BUF}	Bus Free Time Before New Transmission ⁽¹⁾		4.7	—	1.2	—	μs
t _{SU:STA}	Start Condition Setup Time		4.7	—	0.6	—	μs
t _{SU:STO}	Stop Condition Setup Time		4.7	—	0.6	—	μs
t _{HD:STA}	Start Condition Hold Time		4	—	0.6	—	μs
t _{HD:STO}	Stop Condition Hold Time		4	—	0.6	—	μs
t _{SU:DAT}	Data In Setup Time		200	—	100	—	ns
t _{HD:DAT}	Data In Hold Time		0	—	0	—	ns
t _{DH}	Data Out Hold Time	SCL LOW to SDA Data Out Change	100	—	50	—	ns
t _{AA}	Clock to Output	SCL LOW to SDA Data Out Valid	0.1	4.5	0.1	0.9	μs
t _R	SCL and SDA Rise Time ⁽¹⁾		—	1000	—	300	ns
t _F	SCL and SDA Fall Time ⁽¹⁾		—	300	—	300	ns
t _{WR}	Write Cycle Time		—	10	—	5	ms

Note:

1. This parameter is characterized but not 100% tested.

AC ELECTRICAL CHARACTERISTICS (Over Operating Range)**Automotive** ($T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$)

Symbol	Parameter	Test Conditions	2.7V-5.5V		4.5V-5.5V		Unit
			Min.	Max.	Min.	Max.	
f _{SCL}	SCL Clock Frequency		0	100	0	400	KHz
T	Noise Suppression Time ⁽¹⁾		—	100	—	50	ns
t _{LOW}	Clock LOW Period		4.7	—	1.2	—	μs
t _{HIGH}	Clock HIGH Period		4	—	0.6	—	μs
t _{BUF}	Bus Free Time Before New Transmission ⁽¹⁾		4.7	—	1.2	—	μs
t _{SU:STA}	Start Condition Setup Time		4.7	—	0.6	—	μs
t _{SU:STO}	Stop Condition Setup Time		4.7	—	0.6	—	μs
t _{HD:STA}	Start Condition Hold Time		4	—	0.6	—	μs
t _{HD:STO}	Stop Condition Hold Time		4	—	0.6	—	μs
t _{SU:DAT}	Data In Setup Time		200	—	100	—	ns
t _{HD:DAT}	Data In Hold Time		0	—	0	—	ns
t _{DH}	Data Out Hold Time	SCL LOW to SDA Data Out Change	100	—	50	—	ns
t _{AA}	Clock to Output	SCL LOW to SDA Data Out Valid	0.1	4.5	0.1	0.9	μs
t _R	SCL and SDA Rise Time ⁽¹⁾		—	1000	—	300	ns
t _F	SCL and SDA Fall Time ⁽¹⁾		—	300	—	300	ns
t _{WR}	Write Cycle Time		—	10	—	10	ms

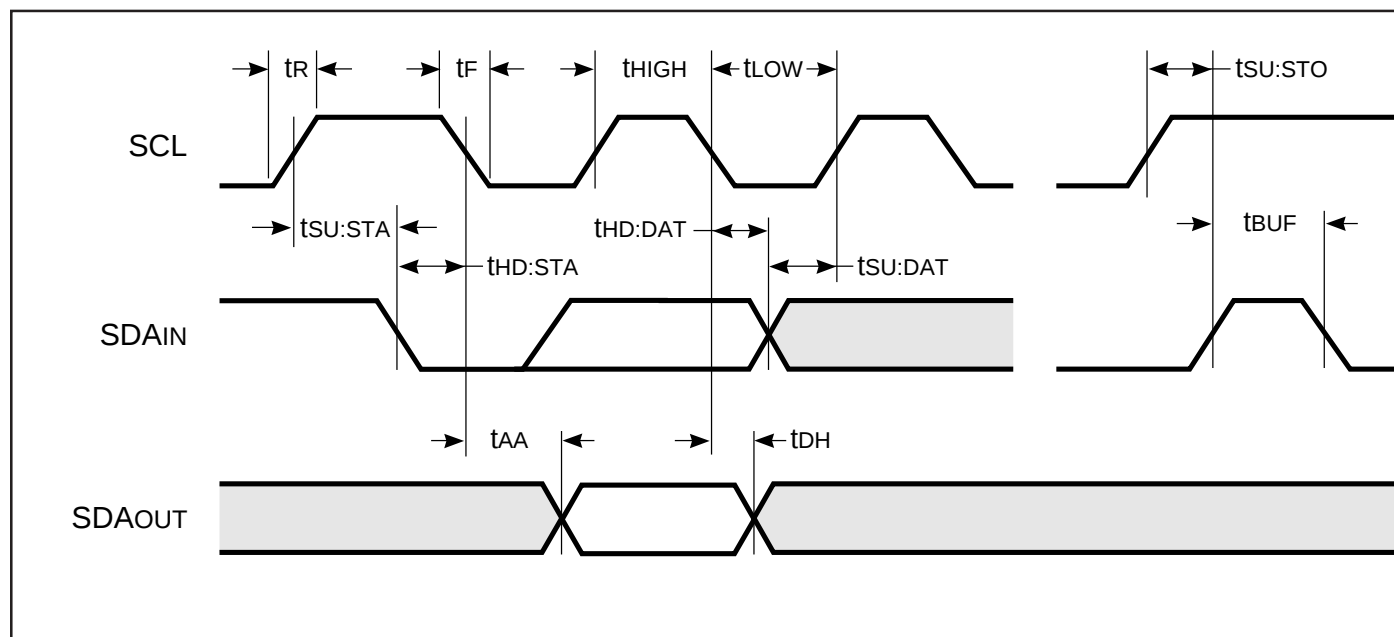
Note:

1. This parameter is characterized but not 100% tested.

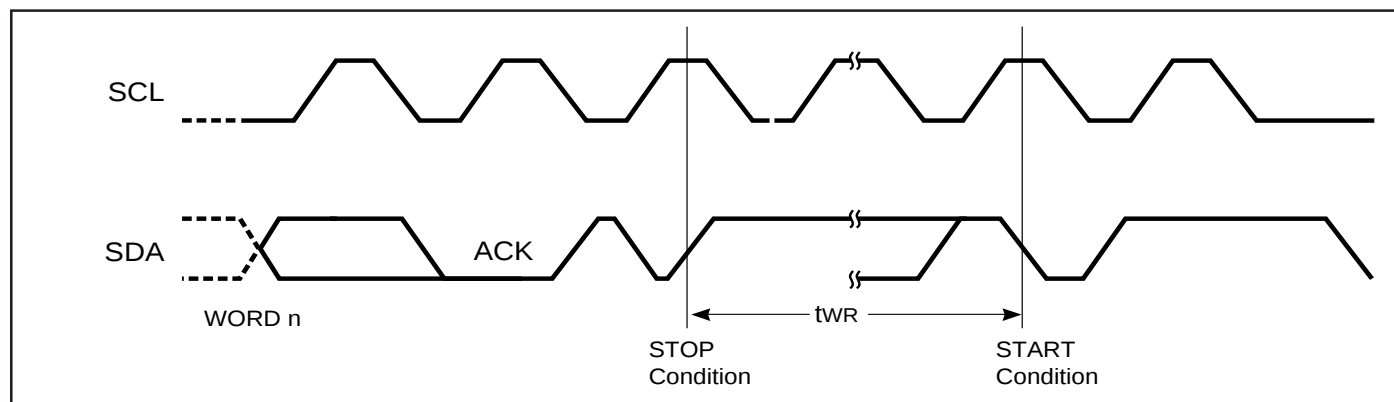
2. Automotive data is preliminary.

AC WAVEFORMS

BUSTIMING



WRITE CYCLE TIMING



ORDERING INFORMATION**Commercial Range: 0°C to +70°C**

Frequency	Voltage Range	Part Number	Package
100 KHz	1.8V to 5.5V	IS24C01-2P	300-mil Plastic DIP
		IS24C01-2G	Small Outline (JEDEC STD)
		IS24C01-2S	MSOP
		IS24C01-2Z	TSSOP
100 KHz	1.8V to 5.5V	IS24C02-2P	300-mil Plastic DIP
		IS24C02-2G	Small Outline (JEDEC STD)
		IS24C02-2S	MSOP
		IS24C02-2Z	TSSOP
100 KHz	1.8V to 5.5V	IS24C04-2P	300-mil Plastic DIP
		IS24C04-2G	Small Outline (JEDEC STD)
		IS24C04-2Z	TSSOP
100 KHz	1.8V to 5.5V	IS24C08-2P	300-mil Plastic DIP
		IS24C08-2G	Small Outline (JEDEC STD)
		IS24C08-2Z	TSSOP
100 KHz	1.8V to 5.5V	IS24C16-2P	300-mil Plastic DIP
		IS24C16-2G	Small Outline (JEDEC STD)
400 KHz	2.5V to 5.5V	IS24C01-3P	300-mil Plastic DIP
		IS24C01-3G	Small Outline (JEDEC STD)
		IS24C01-3S	MSOP
		IS24C01-3Z	TSSOP
400 KHz	2.5V to 5.5V	IS24C02-3P	300-mil Plastic DIP
		IS24C02-3G	Small Outline (JEDEC STD)
		IS24C02-3S	MSOP
		IS24C02-3Z	TSSOP
400 KHz	2.5V to 5.5V	IS24C04-3P	300-mil Plastic DIP
		IS24C04-3G	Small Outline (JEDEC STD)
		IS24C04-3Z	TSSOP
400 KHz	2.5V to 5.5V	IS24C08-3P	300-mil Plastic DIP
		IS24C08-3G	Small Outline (JEDEC STD)
		IS24C08-3Z	TSSOP
400 KHz	2.5V to 5.5V	IS24C16-3P	300-mil Plastic DIP
		IS24C16-3G	Small Outline (JEDEC STD)

ORDERING INFORMATION**Industrial Range: -40°C to +85°C**

Frequency	Voltage Range	Part Number	Package
100 KHz	1.8V to 5.5V	IS24C01-2PI	300-mil Plastic DIP
		IS24C01-2GI	Small Outline (JEDEC STD)
		IS24C01-2SI	MSOP
		IS24C01-2ZI	TSSOP
100 KHz	1.8V to 5.5V	IS24C02-2PI	300-mil Plastic DIP
		IS24C02-2GI	Small Outline (JEDEC STD)
		IS24C02-2SI	MSOP
		IS24C02-2ZI	TSSOP
100 KHz	1.8V to 5.5V	IS24C04-2PI	300-mil Plastic DIP
		IS24C04-2GI	Small Outline (JEDEC STD)
		IS24C04-2ZI	TSSOP
100 KHz	1.8V to 5.5V	IS24C08-2PI	300-mil Plastic DIP
		IS24C08-2GI	Small Outline (JEDEC STD)
		IS24C08-2ZI	TSSOP
100 KHz	1.8V to 5.5V	IS24C16-2PI	300-mil Plastic DIP
		IS24C16-2GI	Small Outline (JEDEC STD)
400 KHz	2.5V to 5.5V	IS24C01-3PI	300-mil Plastic DIP
		IS24C01-3GI	Small Outline (JEDEC STD)
		IS24C01-3SI	MSOP
		IS24C01-3ZI	TSSOP
400 KHz	2.5V to 5.5V	IS24C02-3PI	300-mil Plastic DIP
		IS24C02-3GI	Small Outline (JEDEC STD)
		IS24C02-3SI	MSOP
		IS24C02-3ZI	TSSOP
400 KHz	2.5V to 5.5V	IS24C04-3PI	300-mil Plastic DIP
		IS24C04-3GI	Small Outline (JEDEC STD)
		IS24C04-3ZI	TSSOP
400 KHz	2.5V to 5.5V	IS24C08-3PI	300-mil Plastic DIP
		IS24C08-3GI	Small Outline (JEDEC STD)
		IS24C08-3ZI	TSSOP
400 KHz	2.5V to 5.5V	IS24C16-3PI	300-mil Plastic DIP
		IS24C16-3GI	Small Outline (JEDEC STD)

ORDERING INFORMATION**Automotive Range: –40°C to +125°C**

Frequency	Voltage Range	Part Number	Package
100 KHz	2.7V to 5.5V	IS24C01-3PA	300-mil Plastic DIP
		IS24C01-3GA	Small Outline (JEDEC STD)
		IS24C01-3SA	MSOP
		IS24C01-3ZA	TSSOP
100 KHz	2.7V to 5.5V	IS24C02-3PA	300-mil Plastic DIP
		IS24C02-3GA	Small Outline (JEDEC STD)
		IS24C02-3SA	MSOP
		IS24C02-3ZA	TSSOP
100 KHz	2.7V to 5.5V	IS24C04-3PA	300-mil Plastic DIP
		IS24C04-3GA	Small Outline (JEDEC STD)
		IS24C04-3ZA	TSSOP
100 KHz	2.7V to 5.5V	IS24C08-3PA	300-mil Plastic DIP
		IS24C08-3GA	Small Outline (JEDEC STD)
		IS24C08-3ZA	TSSOP
100 KHz	2.7V to 5.5V	IS24C16-3PA	300-mil Plastic DIP
		IS24C16-3GA	Small Outline (JEDEC STD)
400 KHz	4.5V to 5.5V	IS24C01-5PA	300-mil Plastic DIP
		IS24C01-5GA	Small Outline (JEDEC STD)
		IS24C01-5SA	MSOP
		IS24C01-5ZA	TSSOP
400 KHz	4.5V to 5.5V	IS24C02-5PA	300-mil Plastic DIP
		IS24C02-5GA	Small Outline (JEDEC STD)
		IS24C02-5SA	MSOP
		IS24C02-5ZA	TSSOP
400 KHz	4.5V to 5.5V	IS24C04-5PA	300-mil Plastic DIP
		IS24C04-5GA	Small Outline (JEDEC STD)
		IS24C04-5ZA	TSSOP
400 KHz	4.5V to 5.5V	IS24C08-5PA	300-mil Plastic DIP
		IS24C08-5GA	Small Outline (JEDEC STD)
		IS24C08-5ZA	TSSOP
400 KHz	4.5V to 5.5V	IS24C16-5PA	300-mil Plastic DIP
		IS24C16-5GA	Small Outline (JEDEC STD)

Note: Automotive data is preliminary.